



The MD57XX series is a low-noise LDO that can supply up to 300 mA output current. Designed to meet the requirements of RF and analog circuits, the MD57XX series device provides low noise, high PSRR, low quiescent current, and low line or load transient response figures. Using new innovative design techniques, the MD57XX series offers ultra-low noise performance without a noise bypass capacitor and the ability for remote output capacitor placement.

response figures with a 1- $\mu$ F input and a 1- $\mu$ F output ceramic capacitor

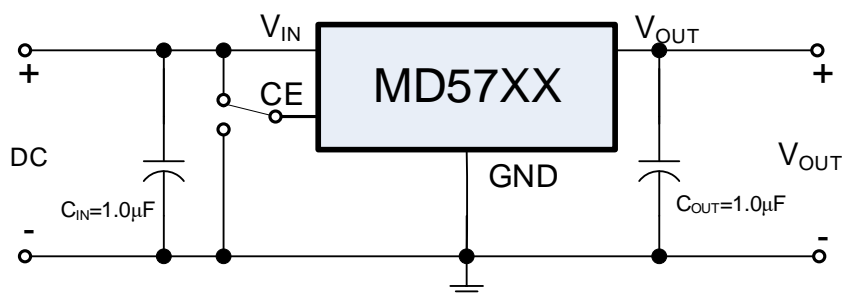
### ■ Features:

- Input Voltage Range: 2.2 V to 5.5 V
- Output Voltage Range: 1.2 V to 4.5 V
- Stable With 1- $\mu$ F Ceramic Input and Output Capacitors
- No Noise Bypass Capacitor Required
- Remote Output Capacitor Placement
- Current Limiter and Over Temperature Protection
- -40°C to 125°C Operating Junction Temperature
- Low Output Voltage Noise: 20 $\mu$ V<sub>RMS</sub>
- High PSRR: 90dB@1kHz
- Output Voltage Tolerance:  $\pm$ 2%
- Low quiescent Current: 20uA
- Low Dropout Voltage: 120mV@300mA

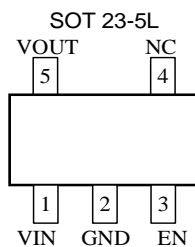
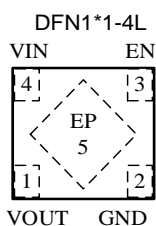
### ■ Applications:

- Mobile Phones, Tablets
- Digital Cameras and Audio Devices
- Portable and Battery-Powered Equipment
- Portable Medical Equipment
- Smart Meters and Field Transmitters
- RF, PLL, VCO, and Clock Power Supplies
- IP Cameras
- Drones

### ■ Typical Application:



■ **Pin Configuration (Top View):**



■ **Product Selections:**

Product Name	V <sub>OUT</sub> (V)	Package	Ordering Name	Marking	Package Information
MD5712	1.2	DFN1*1-4L	MD57E12WB6	5712	Tape and Reel, 10000pcs
MD5715	1.5	DFN1*1-4L	MD57E15WB6	5715	
MD5718	1.8	DFN1*1-4L	MD57E18WB6	5718	
MD5721	2.1	DFN1*1-4L	MD57E21WB6	5721	
MD5725	2.5	DFN1*1-4L	MD57E25WB6	5725	
MD5728	2.8	DFN1*1-4L	MD57E28WB6	5728	
MD5730	3.0	DFN1*1-4L	MD57E30WB6	5730	
MD5733	3.3	DFN1*1-4L	MD57E33WB6	5733	
MD5736	3.6	DFN1*1-4L	MD57E36WB6	5736	
MD5712	1.2	SOT23-5L	MD57E12QC3	5712	Tape and Reel, 3000pcs
MD5715	1.5	SOT23-5L	MD57E15QC3	5715	
MD5718	1.8	SOT23-5L	MD57E18QC3	5718	
MD5721	2.1	SOT23-5L	MD57E21QC3	5721	
MD5725	2.5	SOT23-5L	MD57E25QC3	5725	
MD5728	2.8	SOT23-5L	MD57E28QC3	5728	
MD5730	3.0	SOT23-5L	MD57E30QC3	5730	
MD5733	3.3	SOT23-5L	MD57E33QC3	5733	
MD5736	3.6	SOT23-5L	MD57E36QC3	5736	

**Notes:**

- 1\* Customer can request to customize the output voltage ranged from 1.2V to 4. 5V if desired voltage is not found in the selections.
- 2\* Customer can request customization of package choice.
- 3\* Please pay attention to the MARKING of the product package type.

■ **Ordering Information**

MD57 ①②③④⑤⑥⑦ e.g. MD57E33QC3

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	PIN Configuration	E	
②③	Output Voltage	18~	e.g. 1.8V → ②=1, ③=8
④	Packages Type	Q	SOT23
		W	DFN
⑤	Packages Count	A~Z	e.g. A=3, B=4, C=5 ~
⑥	Minimum Packing Quantity	0~6	0=100, 1=1000, 2=2500, 3=3000, 4=4000, 5=5000, 6=10000
⑦	Customer can request customization of product		

■ **Absolute Maximum Ratings:**

(Unless otherwise indicated:  $T_a=25^\circ\text{C}$ )

PARAMETER	SYMBOL	RATINGS		UNITS
Input Voltage	$V_{IN}$	-0.3 ~ 6.0		V
Output Voltage	$V_{OUT}$	-0.3 ~ $V_{IN}+0.3\text{V}$		
Power Dissipation	$P_D$	SOT23-5L	250	mW
		DFN1*1-4L	200	
Thermal Resistance	$R_{\theta JB}^{(1)}$	SOT23-5L	180	$^\circ\text{C}/\text{W}$
		DFN1*1-4L	160	
Operating Ambient Temperature	$T_{opr}$	-40 ~ +85		$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 ~ +125		
ESD Protection	ESD HBM	6000		V

**Note:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.

<sup>(1)</sup> Mounted on JEDEC standard 4layer (2s2p) PCB test board

■ **Notes on Use:**

Input Capacitor ( $C_{IN}$ ): 1.0 $\mu\text{F}$  above

Output Capacitor ( $C_{OUT}$ ): 1.0 $\mu\text{F}$  above

**Electrical Characteristics:**

MD57XX Series

(Unless otherwise indicated:  $T_a=25^\circ\text{C}$ )

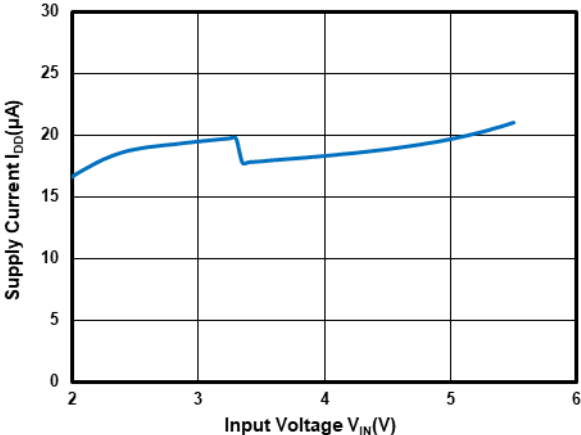
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Output Voltage	$V_{OUT(S)}$	$V_{IN}=V_{OUT(S)}+2.0\text{V}$ $I_{OUT}=1\text{mA}$ , $V_{OUT(S)}<2.0\text{V}$	$V_{OUT(S)}-0.03$	$V_{OUT(S)}$	$V_{OUT(S)}+0.03$	V
		$V_{IN}=V_{OUT(S)}+1.0\text{V}$ $I_{OUT}=1\text{mA}$ , $V_{OUT(S)}\geq 2.0\text{V}$	$V_{OUT(S)}\times 0.98$		$V_{OUT(S)}\times 1.02$	
Dropout Voltage*1	$V_{DROP}$	$V_{EN}=V_{IN}$ , $V_{OUT}<3\text{V}$ $I_{OUT}=300\text{mA}$		130		mV
		$V_{EN}=V_{IN}$ , $V_{OUT}\geq 3\text{V}$ $I_{OUT}=300\text{mA}$		120		
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot V_{OUT(S)}}$	$V_{OUT(S)}+1.0\text{V}\leq V_{IN}=V_{EN}\leq 5.5\text{V}$ $I_{OUT}=10\text{mA}$		0.02	0.1	%/V
Line Transient	$\Delta V_{OUT\_Line}$	$V_{IN}=V_{OUT}+1\text{V}$ to $V_{OUT}+2\text{V}$ in 30us	-1			mV
		$V_{IN}=V_{OUT}+2\text{V}$ to $V_{OUT}+1\text{V}$ in 30us			1	
Load Regulation	$\Delta V_{OUT2}$	$V_{IN}=V_{EN}=V_{OUT(S)}+1.0\text{V}$ $1\text{mA}\leq I_{OUT}\leq 300\text{mA}$		10	20	mV
Load Transient	$\Delta V_{OUT\_Load}$	$I_{OUT}=1\text{mA}$ to $300\text{mA}$ in $10\mu\text{s}$	-40			mV
		$I_{OUT}=300\text{mA}$ to $1\text{mA}$ in $10\mu\text{s}$			40	
Temperature Stability	$\frac{\Delta V_{OUT}}{\Delta T_a \cdot V_{OUT(S)}}$	$V_{IN}=V_{EN}=V_{OUT(S)}+1.0\text{V}$ $I_{OUT}=1\text{mA}$ , $-40^\circ\text{C}\leq T_a\leq 125^\circ\text{C}$		$\pm 100$		ppm/ $^\circ\text{C}$
GND Current ( $V_{EN}=V_{IN}$ )	$I_{GND}$	no load		20	30	$\mu\text{A}$
		$I_{OUT}=300\text{mA}$		470		$\mu\text{A}$
Shutdown Current	$I_{SHUT}$	$V_{IN}=5.5\text{V}$ , $V_{EN}=0$		0.01	0.1	$\mu\text{A}$
Input Voltage	$V_{IN}$	---	2.2		5.5	V
Maximum Output Current	$I_{OUTMAX}$		250	300		mA
Current Limit*2	$I_{LIM}$	$V_{IN}=V_{EN}=V_{OUT(S)}+1.0\text{V}$ $V_{OUT} = 0.95 \times V_{OUT(S)}$		500		mA
$C_{OUT}$ Auto Discharge	$R_{DCHG}$	$V_{EN}=0$ , $V_{OUT}=V_{OUT(S)}$		240		$\Omega$
Power Supply Rejection Ratio	PSRR	$f=1\text{kHz}$ , $I_{OUT}=20\text{mA}$		94		dB
		$f=10\text{kHz}$ , $I_{OUT}=20\text{mA}$		72		
		$f=100\text{kHz}$ , $I_{OUT}=20\text{mA}$		77		
		$f=1\text{MHz}$ , $I_{OUT}=20\text{mA}$		53		
Output noise voltage	$e_N$	$I_{OUT}=20\text{mA}$		20		$\mu\text{V}_{RMS}$
Start-Up Time	$T_{START}$	From $V_{EN}>V_{ENH}$ to $V_{OUT}=95\%$ of $V_{OUT}$		80	150	$\mu\text{s}$
Overshoot on Start-Up	$\Delta V_{OUT\_Start-up}$	Stated as a percentage of $V_{OUT(S)}$			5	%
EN 'H' Level Voltage	$V_{ENH}$	---	0.85		5.5	V
EN 'L' Level Voltage	$V_{ENL}$	---	0		0.35	
EN 'H' Level Current	$I_{ENH}$	$V_{IN}=5.5\text{V}$ , $V_{EN}=V_{IN}$	-0.1		0.1	$\mu\text{A}$
EN 'L' Level Current	$I_{ENL}$	$V_{IN}=5.5\text{V}$ , $V_{EN}=0$	-0.1		0.1	
Over Temperature Protection	OTP	$I_{OUT}=1\text{mA}$		155		$^\circ\text{C}$

**Notes:**

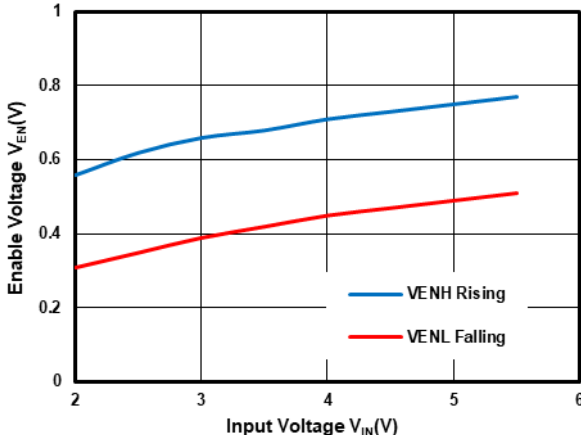
- $V_{DROP}=V_{IN1} - (V_{OUT(S)}\times 0.98)$  where  $V_{IN1}$  is the input voltage when  $V_{OUT} = V_{OUT(S)}\times 0.98$ .
- $I_{LIM}$ : Output current when  $V_{IN}=V_{OUT(S)}+1\text{V}$  and  $V_{OUT} = 0.95 \times V_{OUT(S)}$ .

■ Typical Performance Characteristics:

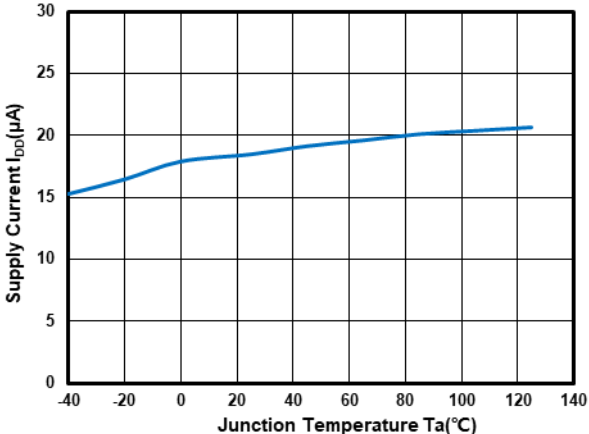
Test Conditions:  $V_{IN}=4.3V$ ,  $V_{OUT}=3.3V$ ,  $C_{IN}=1.0\mu F$ ,  $C_{OUT}=1.0\mu F$ ,  $T_a=25^\circ C$ , unless otherwise indicated.



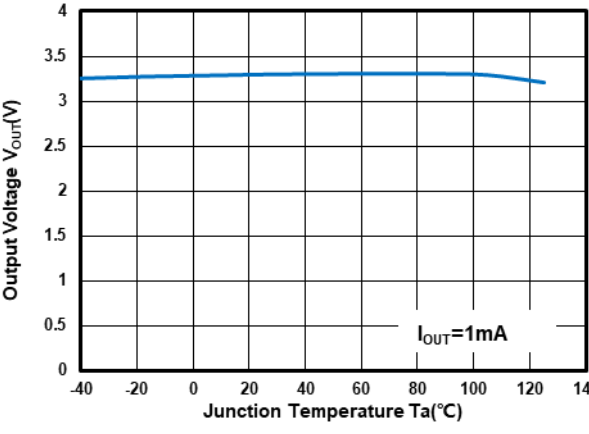
Supply Current vs. Input Voltage



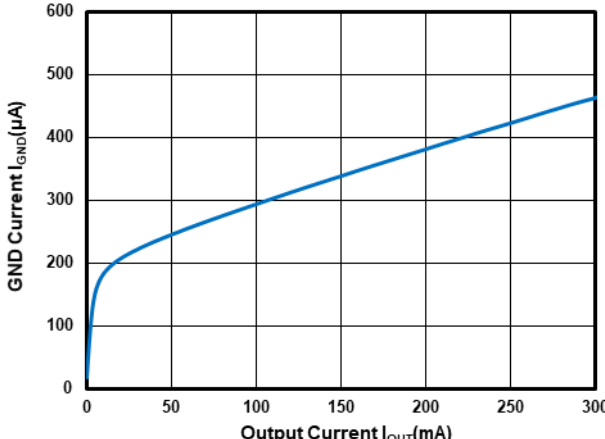
$V_{EN}$  Thresholds vs. Input Voltage



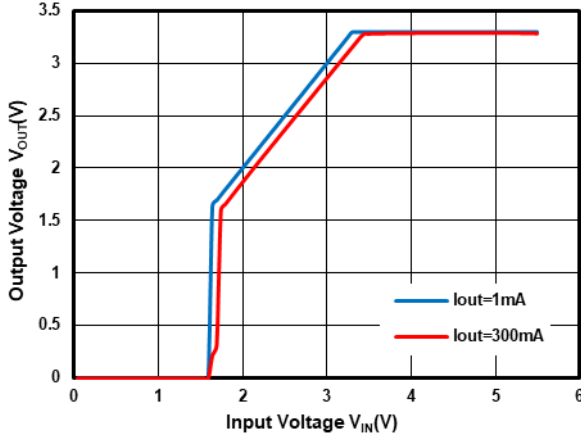
Supply Current vs. Temperature



Output Voltage vs. Temperature



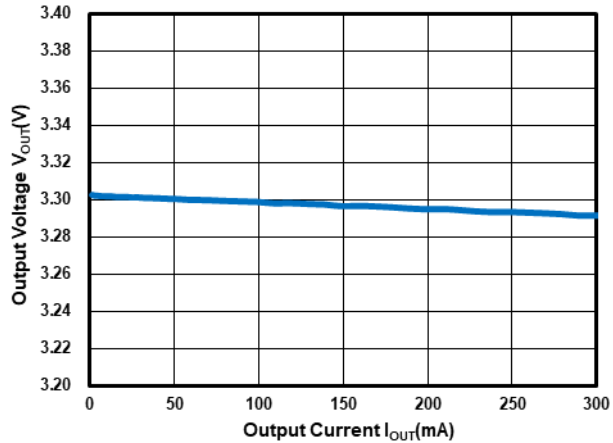
GND Current vs. Output Current



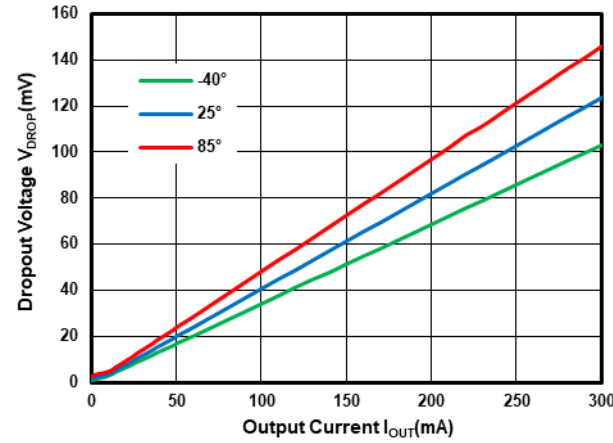
Output Voltage vs. Input Voltage

■ Typical Performance Characteristics (Continued):

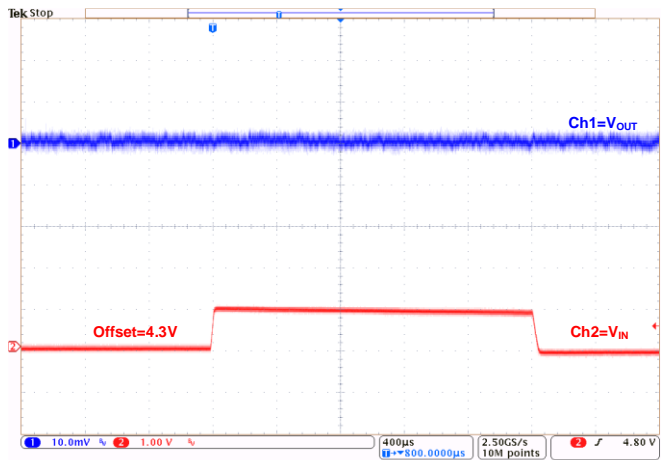
Test Conditions:  $V_{IN}=4.3V$ ,  $V_{OUT}=3.3V$ ,  $C_{IN}=1.0\mu F$ ,  $C_{OUT}=1.0\mu F$ ,  $T_a=25^\circ C$ , unless otherwise indicated.



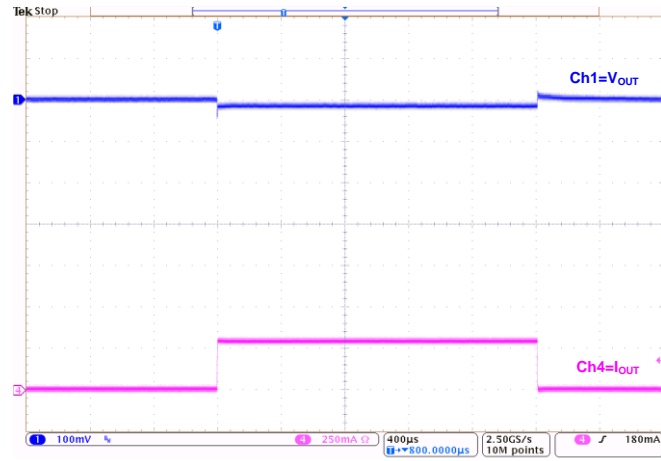
Output Voltage vs. Output Current



Dropout Voltage vs. Output Current



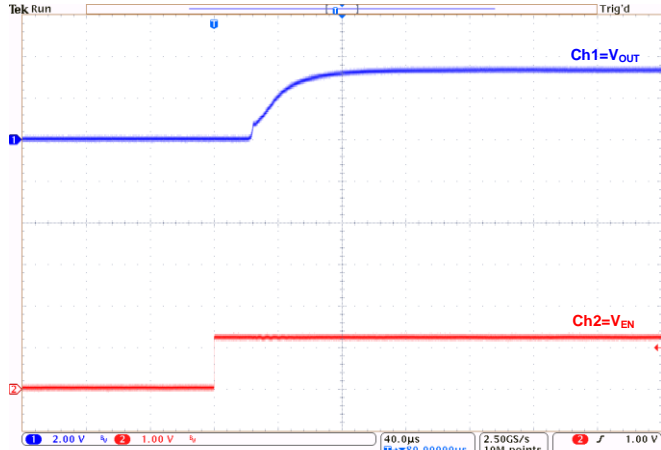
Line Transient:  
( $I_{OUT}=10mA$ )



Load Transient:  
( $I_{OUT}=0mA \sim 300mA \sim 0mA$ )



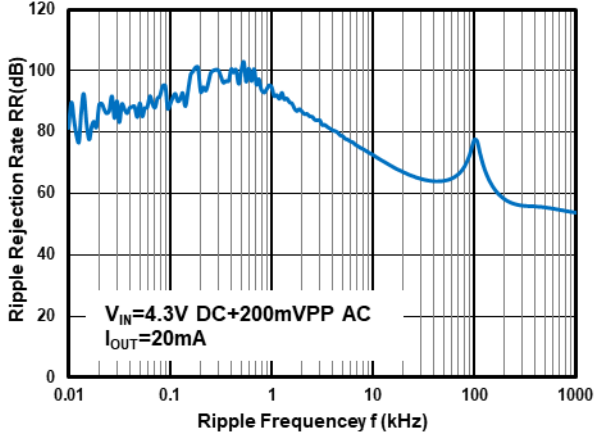
EN Enable:  
( $I_{OUT}=0mA$ )



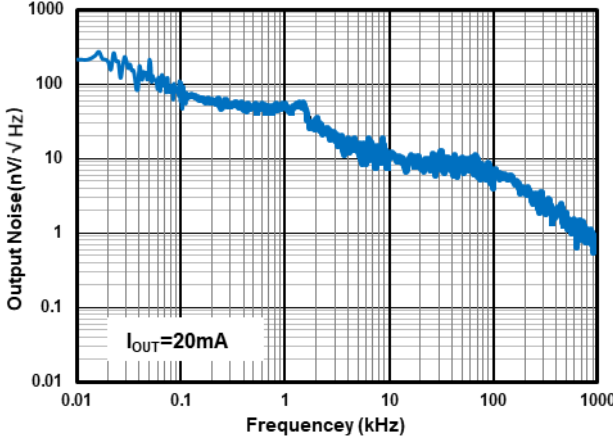
EN Enable:  
( $I_{OUT}=300mA$ )

■ Typical Performance Characteristics (Continued):

Test Conditions:  $V_{IN}=4.3V$ ,  $V_{OUT}=3.3V$ ,  $C_{IN}=1.0\mu F$ ,  $C_{OUT}=1.0\mu F$ ,  $T_a=25^\circ C$ , unless otherwise indicated.



Power Supply Rejection Ratio



Noise Density Test

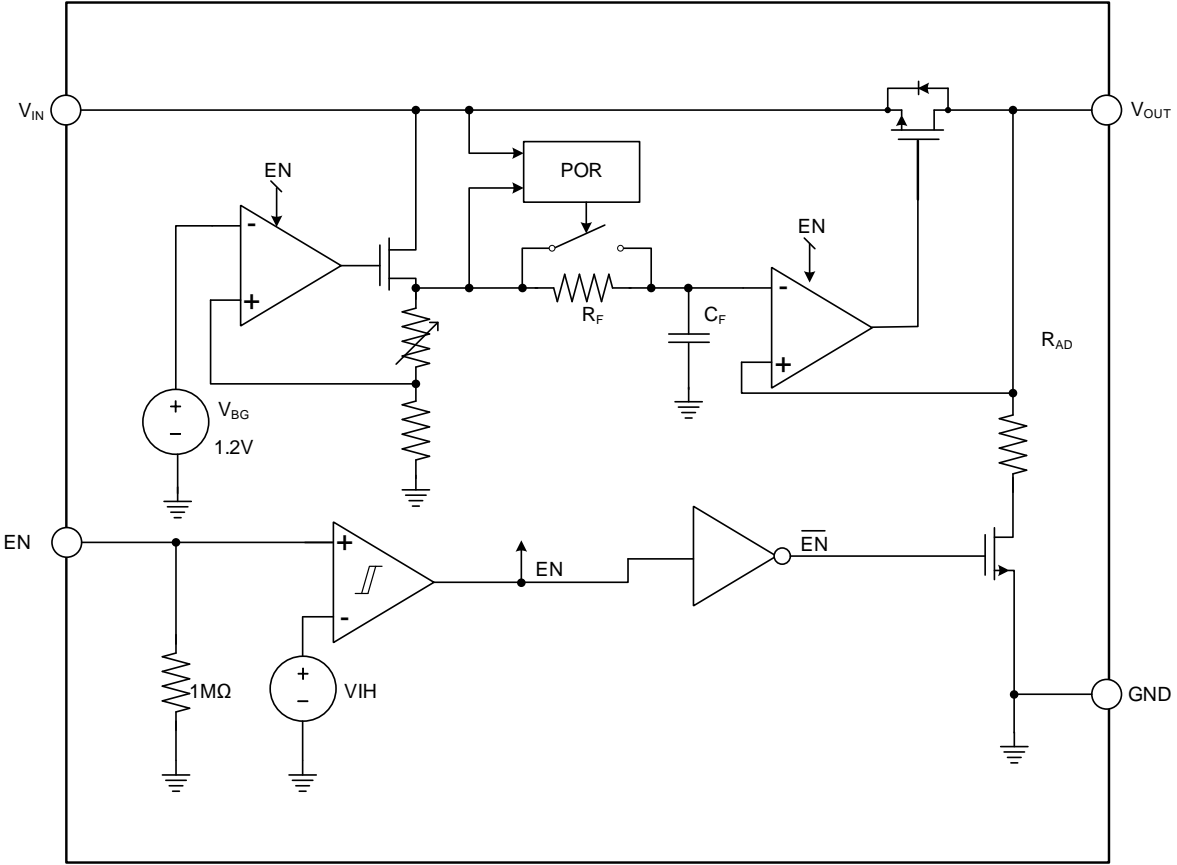
■ Detailed Description:

1. Overview

Using new innovative design techniques, the MD57XX series offers ultra-low noise performance without the need for a separate noise filter capacitor.

The MD57XX series is designed to perform with a single 1- $\mu$ F input capacitor and a single 1- $\mu$ F ceramic output capacitor. With a reasonable PCB layout, the single 1- $\mu$ F ceramic output capacitor can be placed up to 10 cm away from the MD57XX series device.

2. Functional Block Diagram





## ■ Feature Description

### 1. Enable (EN)

The MD57XX series EN pin is internally held low by a 1-M $\Omega$  resistor to GND. The EN pin voltage must be higher than the  $V_{ENH}$  threshold to ensure that the device is fully enabled under all operating conditions. The EN pin voltage must be lower than the  $V_{ENL}$  threshold to ensure that the device is fully disabled and the automatic output discharge is activated.

### 2. Low Output Noise

Any internal noise at the MD57XX series reference voltage is reduced by a first order low-pass RC filter before it is passed to the output buffer stage. The low-pass RC filter has a  $-3$  dB cut-off frequency of approximately 0.1 Hz.

### 3. Output Automatic Discharge

The MD57XX series output employs an internal 240- $\Omega$  (typical) pulldown resistance to discharge the output when the EN pin is low, and the device is disabled

### 4. Remote Output Capacitor Placement

The MD57XX series requires at least a 1- $\mu$ F capacitor at the OUT pin, but there are no strict requirements about the location of the capacitor in regards the OUT pin. In practical designs, the output capacitor may be located up to 10 cm away from the LDO.

### 5. Over Temperature Protection (OTP)

Over temperature protection disables the output when the junction temperature rises to approximately 160°C which allows the device to cool. When the junction temperature cools to approximately 135°C, the output circuitry enables. Based on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This thermal cycling limits the dissipation of the regulator and protects it from damage as a result of overheating.

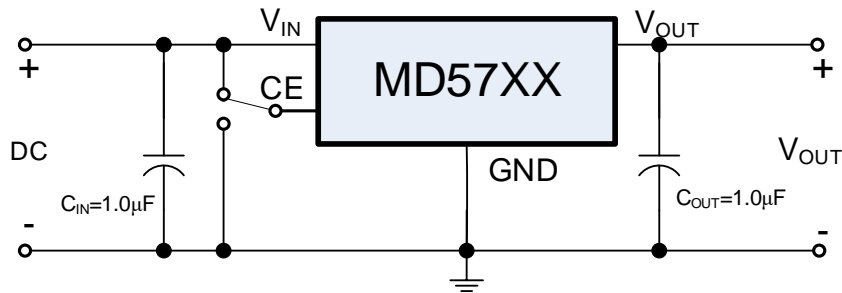
The over temperature protection circuitry of the MD57XX series has been designed to protect against temporary thermal overload conditions. The OTP circuitry was not intended to replace proper heat-sinking. Continuously running the MD57XX series device into thermal shutdown may degrade device reliability.

## ■ Application and Implementation

The MD57XX series is designed to meet the requirements of RF and analog circuits, by providing low noise, high PSRR, low quiescent current, and low line or load transient response figures. The device offers excellent noise performance without the need for a noise bypass capacitor and is stable with input and output capacitors with a value of 1  $\mu\text{F}$ . The MD57XX series delivers this performance in industry standard packages such as SOT23-5, for this device, are specified with an operating junction temperature ( $T_J$ ) of  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

### 1. Typical Application

As the figure shows the typical application circuit for the MD57XX series. Input and output capacitances may need to be increased above the 1  $\mu\text{F}$  minimum for some applications.



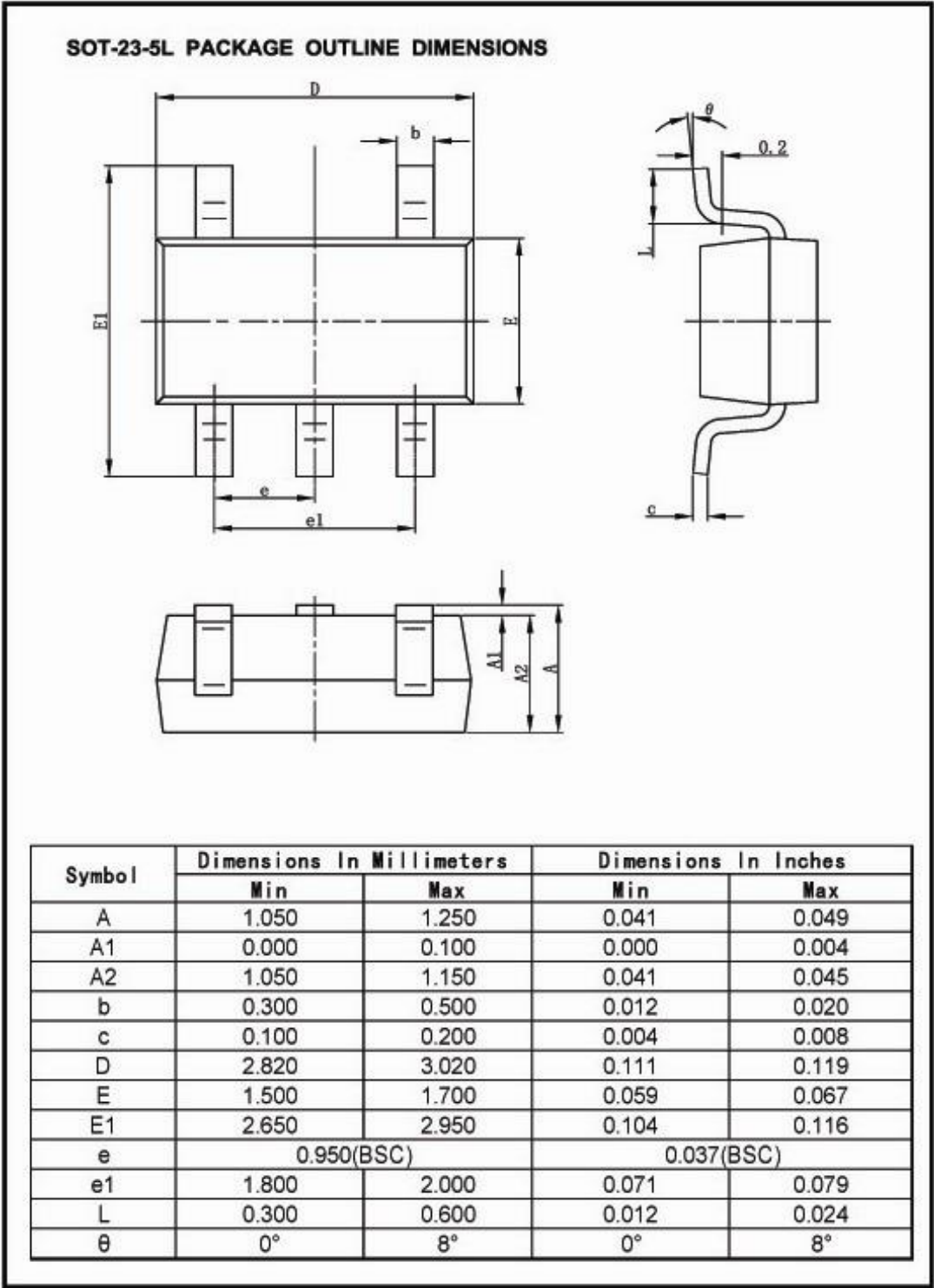
### 2. Design Requirements

DESIGN PARAMETER	EXAMPLE VALUE
Input voltage range	2.2 V to 5.5 V
Output voltage	1.8 V
Output current	300 mA
Output capacitor range	1 $\mu\text{F}$ to 10 $\mu\text{F}$
Input/Output capacitor ESR range	5 to 500 m $\Omega$

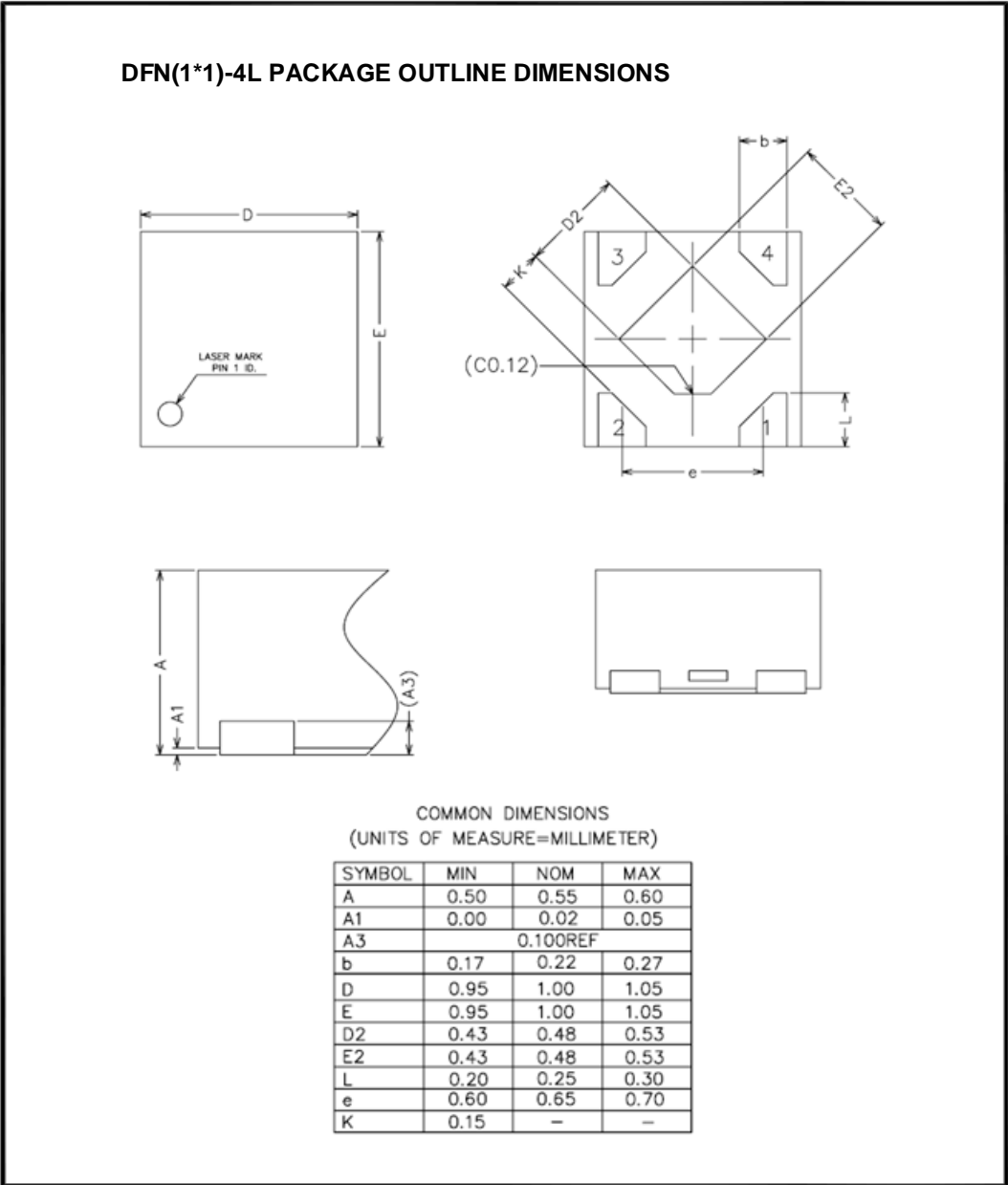
#### Notes:

1. If the impedance of the power supply is high, which is caused by forgetting installing input capacitor or installing too small value capacitor, the oscillation may occur.
2. Pay attention to the operation conditions of input and output voltage and load current, such that the power consumption in the IC should not exceed the allowable power consumption of the package even though the chip has short circuit protection.
3. IC has a built-in anti-static protection (ESD) circuit, but please do not add excessive stress to the IC.

■ Packaging Information



■ Packaging Information (Continued)



For the newest datasheet, please see the website:  
 Version V1.0: 20200528

[www.md-ic.com.cn](http://www.md-ic.com.cn)